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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/814,277	03/21/2001	Toshihiko Hanamachi	6946-10	3964

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EXAMINER

ZERVIGON, RUDY

ART UNIT	PAPER NUMBER
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1763

DATE MAILED: 07/26/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary	Application No.	Applicant(s)	
	09/814,277	HANAMACHI ET AL.	
	Examiner	Art Unit	
	Rudy Zervigon	1763	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 15 May 2006.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1,4-10,13-20 and 22-25 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1,4-10,13-20 and 22-25 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 21 March 2001 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☒ All b) ☐ Some * c) ☐ None of:
1. ☒ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Claim Rejections - 35 USC § 103

1. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

2. Claims 1, 4-7, 9, 13-16, 19, 20, and 22-25 rejected under 35 U.S.C. 103(a) as being unpatentable over Kadomura et al (JP11-121598) in view of Niori; Yusuke et al. (US 5,800,618

A). Kadomura teaches:

- i. A heater (14, 12) device (10; abstract), comprising: a heater (14, 12) defining a substantially horizontal planar upper heating surface (top of 12); and a ceramic plate (13) having a substantially horizontal planar lower surface conforming to and supported by said heating surface (top of 12) but not physically or mechanically fixed (compare with Applicant's Specification - "placed"; [0010], [0015], [0016], [0022]) thereto, the ceramic plate (13) substantially entirely covering said upper heating surface (top of 12), said ceramic plate (13) including an upper supporting surface (top of 13) for supporting an object (atop 13) to be heated by heat conduction through said ceramic plate (13) from said heater (14, 12) to such an object (atop 13), whereby said ceramic plate (13) can be easily placed on and removed from said upper heating surface (top of 12) of said heater (14, 12), wherein said ceramic plate (13) is solid and devoid of openings for passing fluid therethrough and wherein said heater (14, 12) consists of a ceramic heater (14, 12) -
claim 1
- ii. A heater (14, 12) device (10; abstract) according to claim 1, wherein said ceramic plate (13) is substantially made of ceramic material, as claimed by claim 7

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- iii. a heater (14, 12) defining an upper heating surface (top of 12), and a ceramic plate (13) placed on said upper heating surface (top of 12) of said heater (14, 12) without being physically or mechanically fixed (compare with Applicant's Specification - "placed"; [0010], [0015], [0016], [0022]) thereto so that said ceramic plate (13) can be placed on and removed from said upper heating surface (top of 12) of said heater (14, 12), said ceramic plate (13) substantially entirely covering said heating surface (top of 12) and defining a supporting surface for supporting an object (atop 13) of a film forming process, wherein said ceramic plate (13) is solid and devoid of openings for passing fluid there through wherein said ceramic plate (13) is substantially made of ceramic material and wherein said heater (14, 12) consists of a ceramic heater (14, 12) - claim 9
- iv. A film forming device comprising: a process vessel defining a process chamber (25; Figure 2); a heater (14, 12 – part of 10; Figure 2, 1a,b) defining a an upper heating surface (top of 12), said heater (14, 12 – part of 10; Figure 2, 1a,b) being placed in said process chamber; and a ceramic plate (13) placed on said heating surface of said heater (14, 12 – part of 10; Figure 2, 1a,b) without being physically or mechanically fixed (compare with Applicant's Specification - "placed"; [0010], [0015], [0016], [0022]) thereto so that said ceramic plate (13) can be placed on and removed from said upper heating surface (top of 12) of said heater (14, 12), said ceramic plate (13) substantially entirely covering said heating surface (top of 12), the ceramic plate (13) defining a supporting surface for supporting an object (40; Figure 2) of a film forming process, wherein said ceramic plate (13) is solid and devoid of openings for passing fluid therethrough - claim 14

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- v. A film forming device according to claim 9, wherein said ceramic plate (13) has a thickness of no more than 5 mm, as claimed by claim 15
- vi. A film forming device according to claim 9, wherein said ceramic plate (13) is substantially made of ceramic material, as claimed by claim 16
- vii. a heater (14, 12) defining a upper heating surface (top of 12); and a ceramic plate (13) “simply” detachably placed on said upper heating surface (top of 12) of said heater (14, 12) without being physically or mechanically fixed (compare with Applicant’s Specification - “placed”; [0010], [0015], [0016], [0022]) thereto so that said ceramic plate (13) can be placed on and removed from said upper heating surface (top of 12) of said heater (14, 12), said ceramic plate (13) substantially entirely covering said heating surface (top of 12) and defining a supporting surface for supporting an object (atop 13) of a film forming process, wherein said ceramic plate (13) is substantially made of ceramic material, and said ceramic plate (13) is substantially made of ceramic material and wherein said heater (14, 12) consists of a ceramic heater (14, 12) - claim 20
- viii. a heater (14, 12) device (10; abstract), comprising: a heater (14, 12) defining a substantially horizontal planar upper upper heating surface (top of 12); and a ceramic plate (13) having a substantially horizontal planar lower surface conforming to and supported by said upper heating surface (top of 12) but not physically or mechanically fixed (compare with Applicant’s Specification - “placed”; [0010], [0015], [0016], [0022]) thereto, the ceramic plate (13) substantially entirely covering said upper upper heating surface (top of 12), said ceramic plate (13) including an upper supporting surface (top of 13) (top of 13) for supporting an object (atop 13) to be heated by heat conduction through

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said ceramic plate (13) from said heater (14, 12) to such an object (atop 13), whereby said ceramic plate (13) can be easily placed on and removed from said upper upper heating surface (top of 12) of said heater (14, 12), wherein said ceramic plate (13) is substantially made of ceramic material and wherein said heater (14, 12) consists of a ceramic heater (14, 12) - claim 22

- ix. The heater (14, 12) device (10; abstract) of claim 22, wherein said ceramic plate (13) is directly placed on said upper upper heating surface (top of 12), as claimed by claim 23

Applicant's claim requirements of "so that said ceramic plate can be placed on and removed from said upper heating surface of said heater, said ceramic plate" appears to be a claim requirement of intended use. When the structure recited in the reference is substantially identical to that of the claims, claimed properties or functions are presumed to be inherent (In re Best, 562 F.2d 1252, 1255, 195 USPQ 430, 433 (CCPA 1977); MPEP 2112.01). Further, it has been held that claim language that simply specifies an intended use or field of use for the invention generally will not limit the scope of a claim (Walter, 618 F.2d at 769, 205 USPQ at 409; MPEP 2106). Additionally, in apparatus claims, intended use must result in a structural difference between the claimed invention and the prior art in order to patentably distinguish the claimed invention from the prior art. If the prior art structure is capable of performing the intended use, then it meets the claim (In re Casey, 152 USPQ 235 (CCPA 1967); In re Otto, 136 USPQ 458, 459 (CCPA 1963); MPEP 2111.02).

Kadomura does not teach:

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- i. wherein said heater (14, 12) consists of a ceramic heater (14, 12) and an electrode for radio frequency power is buried in said ceramic heater, as claimed by claim 1, 9, 14, 20, 22
- ii. A heater (14, 12) device (10; abstract) according to claim 2, wherein an electrode for radio frequency power is buried in said ceramic heater (14, 12), as claimed by claim 3
- iii. A heater (14, 12) device (10; abstract) according to claim 1, wherein an electrode for radio frequency power is buried in said ceramic plate (13), as claimed by claim 5
- iv. A film forming device, comprising: a process vessel defining a process chamber; said heater (14, 12) being placed in said process chamber – claim 9, 20
- v. A film forming device according to claim 9, wherein said ceramic plate (13) has a thickness of no more than 2 mm, as claimed by claim 13
- vi. The heater device of claim 1, wherein the thickness ranges from 1mm to 5mm, as claimed by claim 25

Niori teaches wafer support means (53; Figure 10; column 16, lines 45-65) with embedded high-frequency electrodes (30).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to add Kadomura's ceramic plate (13), with an embedded electrode and optimized dimension, in the apparatus of Niori as taught by Kadomura and Niori.

Motivation to add Kadomura's ceramic plate (13), with an embedded electrode and optimized dimension, in the apparatus of Niori as taught by Niori is for generating a capacitive plasma during plasma processing as taught by Niori (abstract). Further, it is well established that changes in apparatus dimensions are within the level of ordinary skill in the art. (Gardner v. TEC Systems,

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Inc. , 725 F.2d 1338, 220 USPQ 777 (Fed. Cir. 1984), cert. denied , 469 U.S. 830, 225 USPQ 232 (1984); In re Rose , 220 F.2d 459, 105 USPQ 237 (CCPA 1955); In re Rinehart, 531 F.2d 1048, 189 USPQ 143 (CCPA 1976); See MPEP 2144.04).

3. Claims 8, 10, 17, and 18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kadomura et al (JP11-121598) in view of Selbrede; Steven C. (US 5,094,885 A). Kadomura is discussed above. Kadomura does not teach:

- i. A heater (14, 12) device (10; abstract) according to claim 1, 9, wherein said ceramic plate (13) further comprises a low annular wall surrounding said upper supporting surface (top of 13), as claimed by claim 8, 17
- ii. A heater (14, 12) device (10; abstract) according to claim 7,16, wherein said ceramic material consists essentially of aluminum nitride, magnesia, or alumina, as claimed by claim 10, 18

Selbrede teaches an alumina wafer clamp ring (29; Figure 3; column 9, lines 36-44) including an annular low wall (103; Figure 3) for supporting a substrate.

It would have been obvious to one of ordinary skill in the art at the time the invention was made to add an annular low wall in Kadomura's ceramic plate made from alumina as taught by Selbrede.

Motivation to add an annular low wall in Kadomura's ceramic plate made from alumina as taught by Selbrede is for securing a processed wafer as taught by Selbrede (column 4, lines 34-45) made of materials is for processing compatibility as taught by Selbrede (column 9, lines 36-44).

Response to Arguments

4. Applicant's arguments with respect to claims 1, 4-10, 13-20, and 22-25 have been considered but are moot in view of the new grounds of rejection.

5. The Examiner's position concerning Applicant's claim amendments, and arguments in support therefore, are addressed in the above new grounds of rejection.

Conclusion

6. Applicant's amendment necessitated the new grounds of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Examiner Rudy Zervigon whose telephone number is (571) 272-1442. The examiner can normally be reached on a Monday through Thursday schedule from 8am through 7pm. The official fax phone number for the 1763 art unit is (571) 273-8300. Any Inquiry of a general nature or relating to the status of this application or proceeding should be directed to

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the Chemical and Materials Engineering art unit receptionist at (571) 272-1700. If the examiner can not be reached please contact the examiner's supervisor, Parviz Hassanzadeh, at (571) 272-1435.

Prof. Zeng
7/23/6